

In The Specification

Please replace the paragraph on page 9, line 8 with the following paragraph:

A1
The cover layer 36a is machined to provide a hole 39a through which an electrode 32 is exposed in a predetermined position of the conductor pattern 22 on the top layer, and so is the cover layer 36b to provide another hole 39a through which an electrode 37 is exposed in a predetermined position of the conductor pattern 22 on the bottom layer. In this embodiment, the same resin film as for the resin film 23, which is a thermoplastic film with 25 - 75 μ m thickness, made of a mixture of 65 - 35 % polyetheretherketone resin and 35 - 65 % polyetherimide resin, is used for the cover layers 36a and 36b.